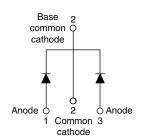


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Schottky Rectifier, 2 x 15 A

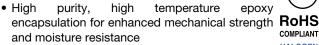




PRODUCT SUMMARY						
Package	TO-220AB					
I _{F(AV)}	2 x 15 A					
V_{R}	30 V					
V _F at I _F	0.37 V					
I _{RM} max.	350 mA at 125 °C					
T _J max.	150 °C					
Diode variation	Common cathode					
E _{AS}	15 mJ					

FEATURES

- 150 °C T_J operation
- · Very low forward voltage drop
- High frequency operation





- Guard ring for enhanced ruggedness and long FREE term reliability
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)

DESCRIPTION

This center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL CHARACTERISTICS VALUES UNITS						
I _{F(AV)}	Rectangular waveform	30	A			
V _{RRM}		30	V			
V _F	15 A _{pk} , T _J = 125 °C (per leg)	0.37	V			
TJ	Range	- 55 to 150	°C			

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-30L30CTPBF	VS-30L30CT-N3	UNITS		
Maximum DC reverse voltage	V _R	30	30	V		
Maximum working peak reverse voltage	V_{RWM}	30	30	V		

ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST CONDITIONS		TEST CONDITIONS		VALUES	UNITS
Maximum average	per device		50.0/ dutu cuela at T		30			
forward current per leg		I _{F(AV)}	50 % duty cycle at T _C = 140 °C, rectangular waveform		15			
Maximum peak one cycle non-repetitive surge current	I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated	1450	Α			
		10 ms sine or 6 ms rect. pulse	V _{RRM} applied	220				
Non-repetitive avalanche energy per leg		E _{AS}	T _J = 25 °C, I _{AS} = 2 A, L = 7.5 mH		15	mJ		
Repetitive avalanche current per leg		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		2	А		



VS-30L30CTPbF, VS-30L30CT-N3

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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS		
Maximum forward voltage drop per leg		15 A	T 05.00	0.46	V	
	V _{FM} ⁽¹⁾	30 A	T _J = 25 °C	0.57		
		15 A	T _{.1} = 125 °C	0.37		
		30 A	1J = 125 C	0.50		
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V _B = Rated V _B	1.50	mA	
Maximum reverse leakage current per leg		T _J = 125 °C	VR = nateu VR	350		
Maximum junction capacitance per leg	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz) 25 °C		1500	pF	
Typical series inductance per leg	L _S	Measured lead to lead 5 mm from package body		8.0	nΗ	
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs	

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range		T _J , T _{Stg}		- 55 to 150	°C		
Maximum thermal resistance, junction to case per leg		В	DC operation	1.5	°C/W		
Maximum thermal resistance, junction to case per package		R _{thJC}		0.8			
Approximate weight				2.0	g		
Approximate weight				0.07	oz.		
Mounting torque —	minimum			6 (5)	kgf ⋅ cm		
wounting torque —	maximum			12 (10)	(lbf \cdot in)		
Marking device	•		Case style TO-220AB	30L3	BOCT		

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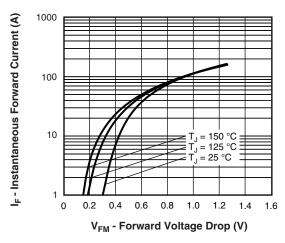


Fig. 1 - Maximum Forward Voltage Drop Characteristics

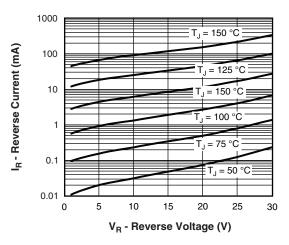


Fig. 2 - Typical Values of Reverse Current vs.
Reverse Voltage

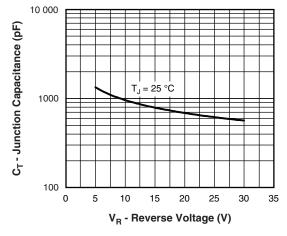


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

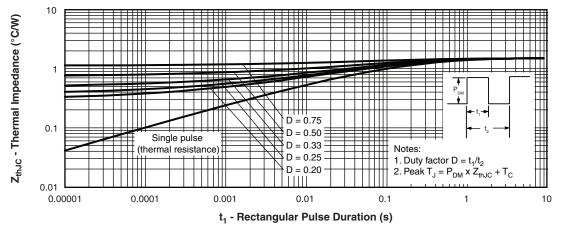


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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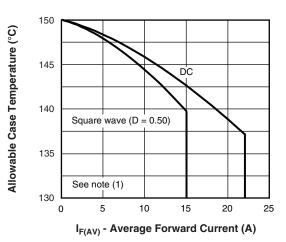


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

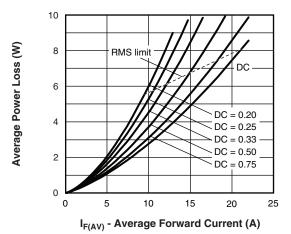


Fig. 6 - Forward Power Loss Characteristics

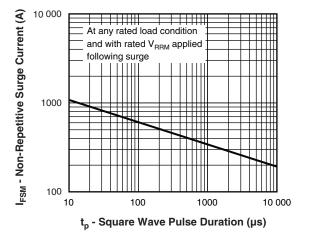


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

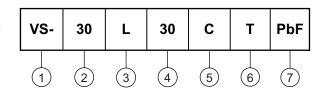
 $^{(1)}$ Formula used: T_C = T_J - Pd x R_{th,JC}; Pd = Forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6)

VS-30L30CTPbF, VS-30L30CT-N3

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product

Current rating (30 = 30 A)

Schottky "L" series

Voltage rating (30 = 30 V)

5 - C = Common cathode

6 - Package:

T = TO-220

7 - Environmental digit

• PbF = Lead (Pb)-free and RoHS compliant

• -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-30L30CTPbF	50	1000	Antistatic plastic tube				
VS-30L30CT-N3	50	1000	Antistatic plastic tube				

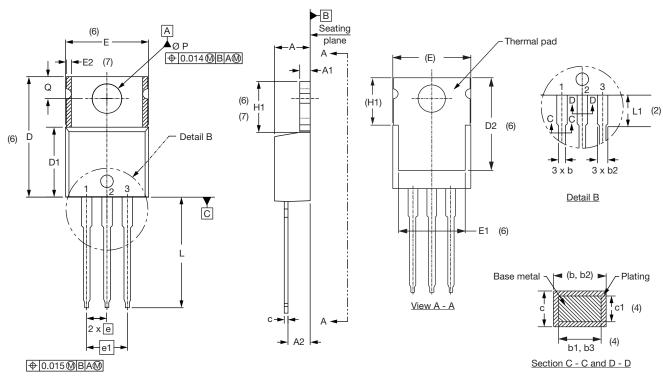
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95222</u>					
Death are adding a information	TO-220AB PbF	www.vishay.com/doc?95225			
Part marking information	TO-220AB -N3	www.vishay.com/doc?95028			
SPICE model		www.vishay.com/doc?95287			



Vishay Semiconductors

TO-220AB

DIMENSIONS in millimeters and inches



Lead assignments

<u>Diodes</u>

- 1. Anode/open
- 2. Cathode
- 3. Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6

SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STIMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØΡ	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° to 93°		90° t	o 93°	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline

Lead tip

Legal Disclaimer Notice



Vishay

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